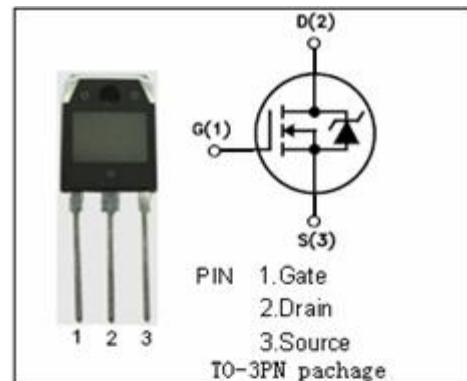


isc N-Channel MOSFET Transistor

18N60

• FEATURES

- Drain Current $I_D = 18A @ T_C=25^\circ C$
- Drain Source Voltage : $V_{DSS} = 600V$ (Min)
- Static Drain-Source On-Resistance : $R_{DS(on)} = 0.4 \Omega$ (Max)
- Fast Switching



• APPLICATIONS

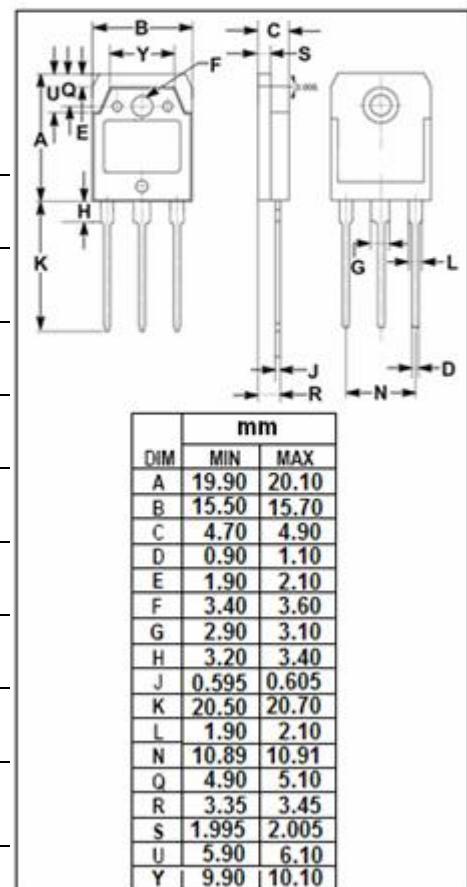
- Switch mode power supply.

• ABSOLUTE MAXIMUM RATINGS($T_a=25^\circ C$)

SYMBOL	PARAMETER	VALUE	UNIT
V_{DSS}	Drain-Source Voltage	600	V
V_{GS}	Gate-Source Voltage-Continuous	± 30	V
I_D	Drain Current-Continuous	18	A
I_{DM}	Drain Current-Single Plused	45	A
P_D	Total Dissipation @ $T_C=25^\circ C$	360	W
T_j	Max. Operating Junction Temperature	150	$^\circ C$
T_{stg}	Storage Temperature	-55~150	$^\circ C$

• THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	MAX	UNIT
$R_{th j-c}$	Thermal Resistance, Junction to Case	0.35	$^\circ C/W$



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• ELECTRICAL CHARACTERISTICS

 $T_c=25^\circ\text{C}$ unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN	TYPE	MAX	UNIT
$V_{(\text{BR})\text{DSS}}$	Drain-Source Breakdown Voltage	$V_{GS}=0$; $I_D=250\mu\text{A}$	600			V
$V_{GS(\text{th})}$	Gate Threshold Voltage	$V_{DS}=5\text{V}$; $I_D=250\mu\text{A}$	2.0		4.0	V
V_{SD}	Diode Forward On-voltage	$I_S=18\text{A}$; $V_{GS}=0$			1.5	V
$R_{DS(\text{on})}$	Drain-Source On-Resistance	$V_{GS}=10\text{V}$; $I_D=9\text{A}$			0.4	Ω
I_{GSS}	Gate-Body Leakage Current	$V_{GS}=\pm 30\text{V}$; $V_{DS}=0$			± 100	nA
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS}=600\text{V}$; $V_{GS}=0$			25	μA
C_{iss}	Input Capacitance	$V_{DS}=25\text{V}$; $V_{GS}=0\text{V}$; $f_T=1\text{MHz}$		2500		pF
C_{rss}	Reverse Transfer capacitance			23		
C_{oss}	Output Capacitance			280		
t_r	Rise Time	$V_{GS}=10\text{V}$; $I_D=9\text{A}$; $V_{DD}=300\text{V}$; $R_L=50\Omega$		22		ns
$t_{d(on)}$	Turn-on Delay Time			21		
t_f	Fall Time			22		
$t_{d(off)}$	Turn-off Delay Time			62		

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